

HAT1021R

Silicon P Channel Power MOS FET
High Speed Power Switching

HITACHI

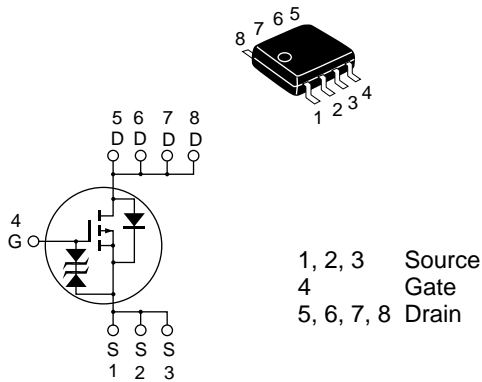
ADE-208-475 D (Z)
5th. Edition
February 1999

Features

- Low on-resistance
- Capable of 2.5 V gate drive
- Low drive current
- High density mounting

Outline

SOP-8



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	- 20	V
Gate to source voltage	V_{GSS}	± 10	V
Drain current	I_D	- 5.5	A
Drain peak current	$I_{D(pulse)}$ ^{Note1}	- 44	A
Body-drain diode reverse drain current	I_{DR}	- 5.5	A
Channel dissipation	Pch ^{Note2}	2.5	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

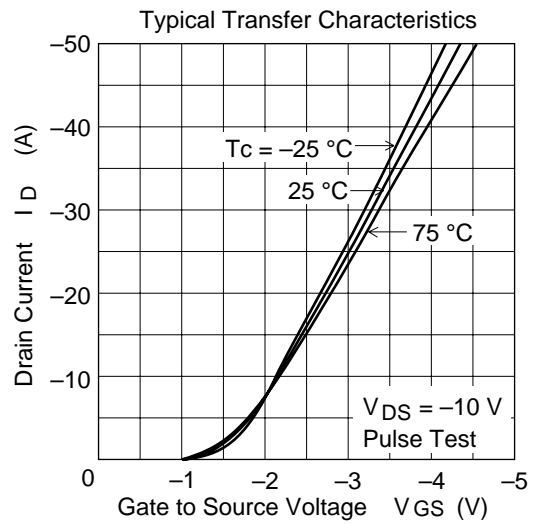
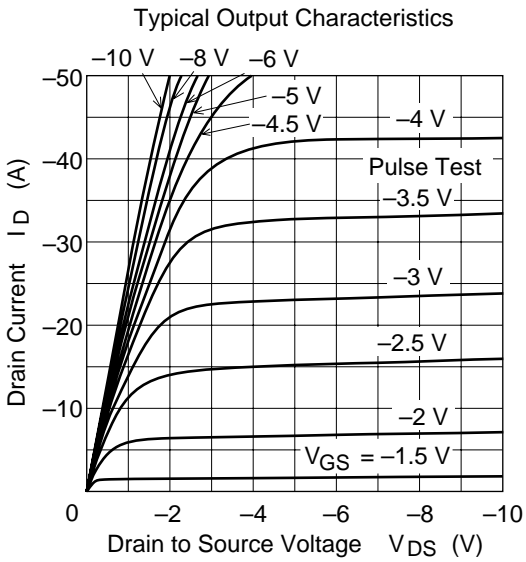
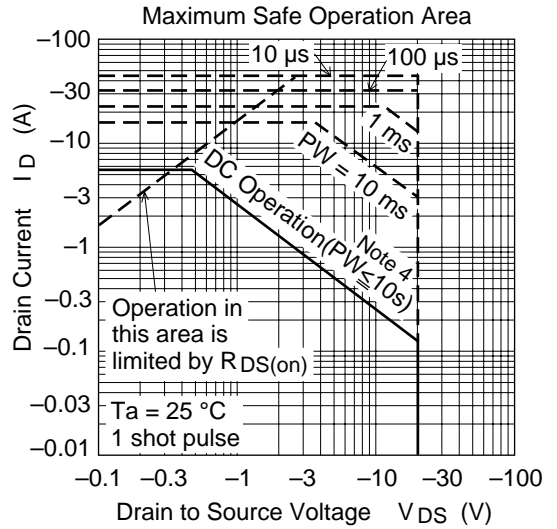
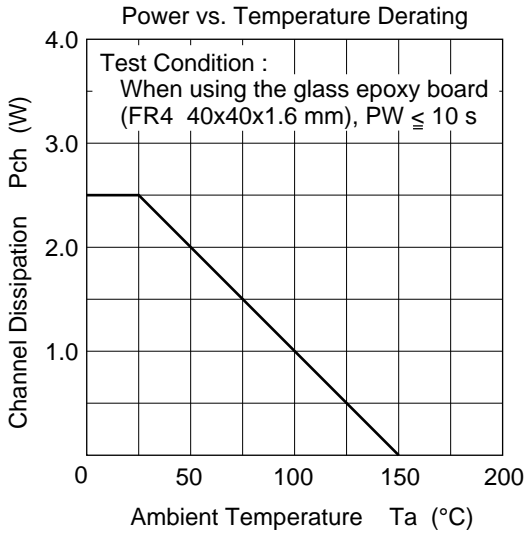
Note: 1. $PW \leq 10\mu s$, duty cycle $\leq 1\%$
 2. When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), $PW \leq 10s$

Electrical Characteristics (Ta = 25°C)

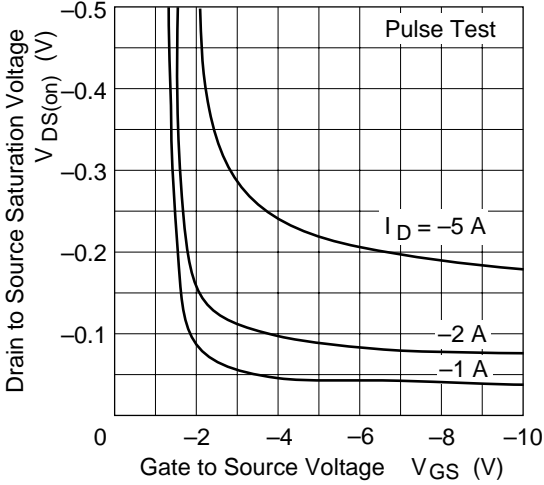
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	- 20	—	—	V	$I_D = -10\text{ mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	± 10	—	—	V	$I_G = \pm 100\ \mu A$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 8\text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	- 10	μA	$V_{DS} = -20\text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	- 0.5	—	- 1.5	V	$V_{DS} = -10\text{ V}$, $I_D = -1\text{ mA}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.048	0.060	Ω	$I_D = -3\text{ A}$, $V_{GS} = -4\text{ V}$ ^{Note3}
	$R_{DS(on)}$	—	0.065	0.085	Ω	$I_D = -3\text{ A}$, $V_{GS} = -2.5\text{ V}$ ^{Note3}
Forward transfer admittance	$ y_{fs} $	6	9.5	—	S	$I_D = -3\text{ A}$, $V_{DS} = -10\text{ V}$ ^{Note3}
Input capacitance	Ciss	—	1200	—	pF	$V_{DS} = -10\text{ V}$
Output capacitance	Coss	—	630	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	200	—	pF	f = 1MHz
Turn-on delay time	$t_{d(on)}$	—	20	—	ns	$V_{GS} = -4\text{ V}$, $I_D = -3\text{ A}$
Rise time	t_r	—	120	—	ns	$V_{DD} \cong -10\text{ V}$
Turn-off delay time	$t_{d(off)}$	—	175	—	ns	
Fall time	t_f	—	140	—	ns	
Body-drain diode forward voltage	V_{DF}	—	- 0.9	- 1.4	V	$I_F = -5.5\text{ A}$, $V_{GS} = 0$ ^{Note3}
Body-drain diode reverse recovery time	t_{rr}	—	65	—	ns	$I_F = -5.5\text{ A}$, $V_{GS} = 0$ diF/ dt = 20 A/ μs

Note: 3. Pulse test

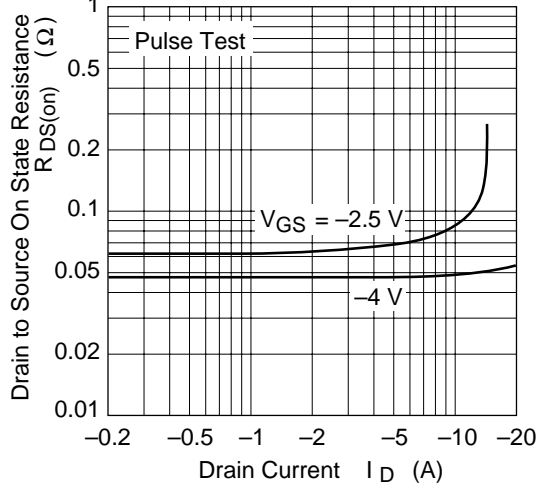
Main Characteristics



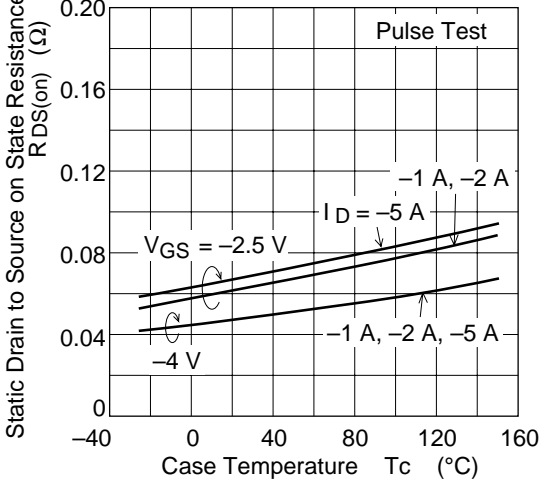
Drain to Source Saturation Voltage vs. Gate to Source Voltage



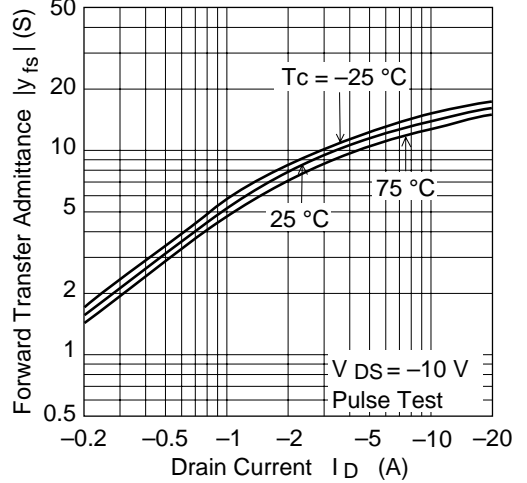
Static Drain to Source on State Resistance vs. Drain Current

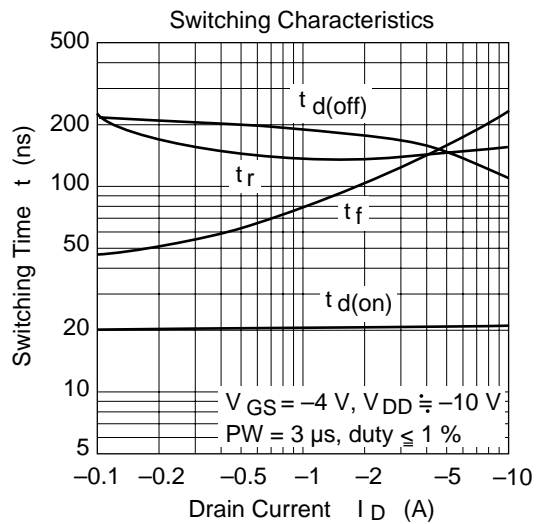
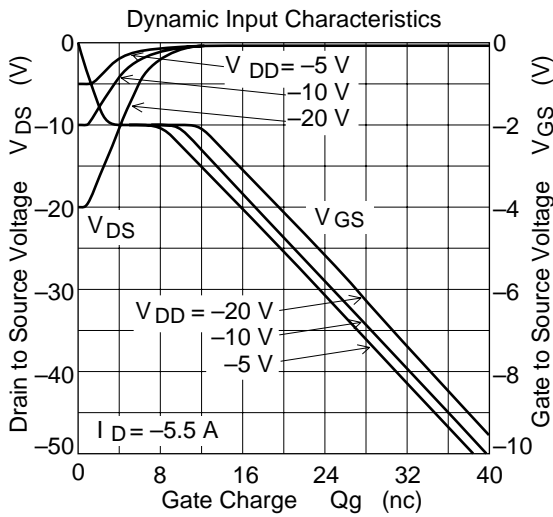
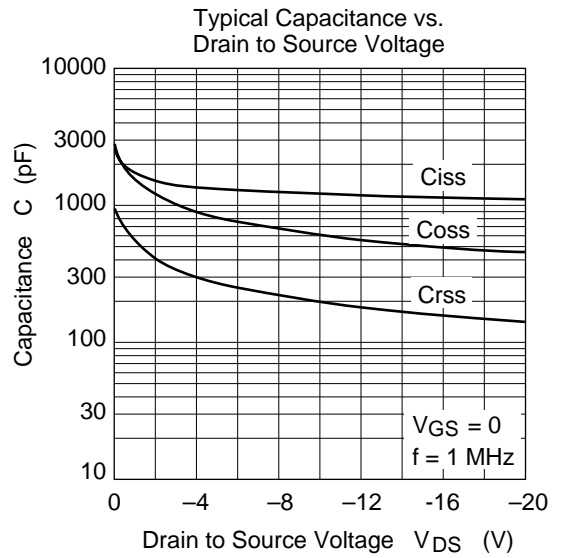
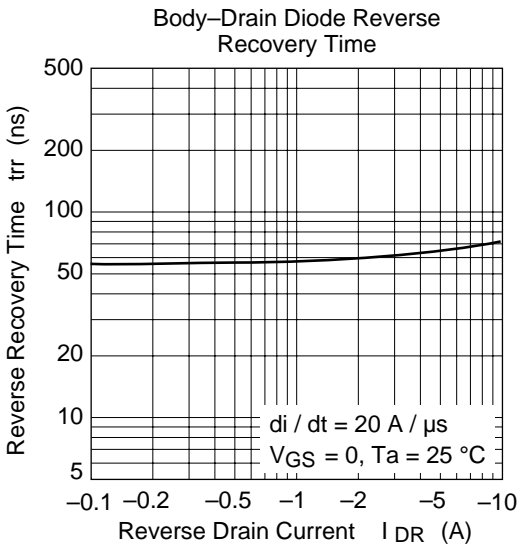


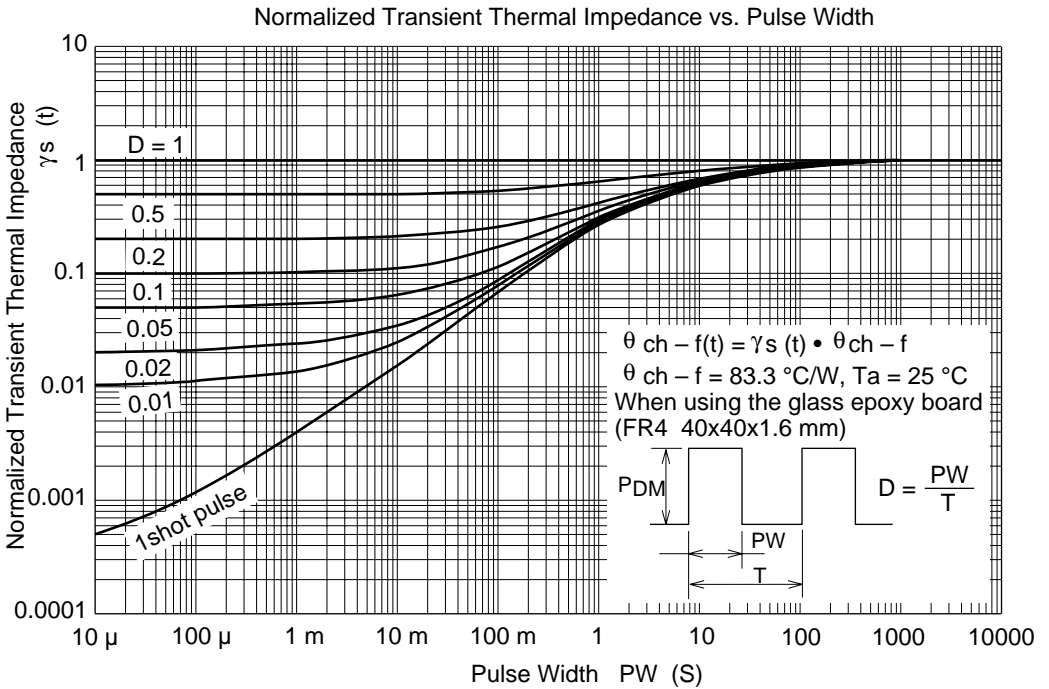
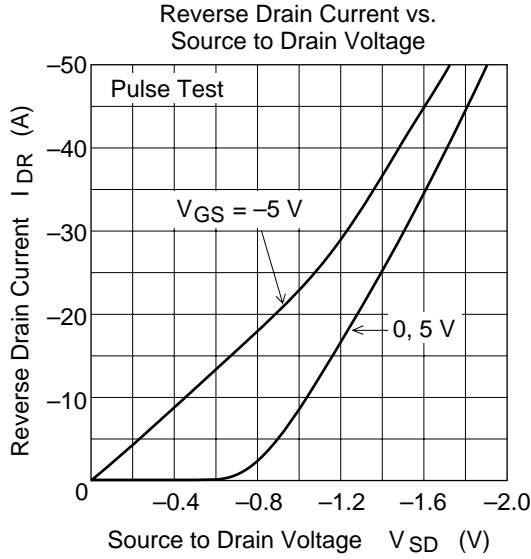
Static Drain to Source on State Resistance vs. Temperature



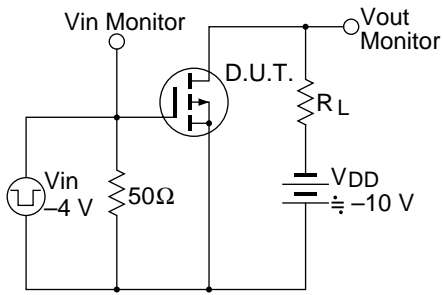
Forward Transfer Admittance vs. Drain Current



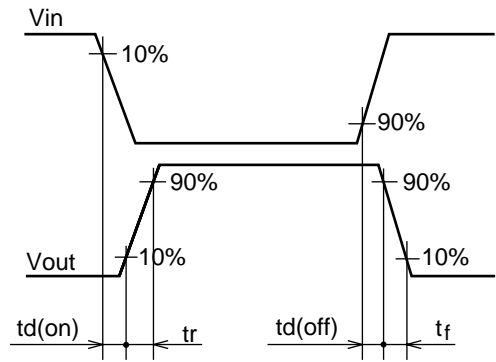




Switching Time Test Circuit

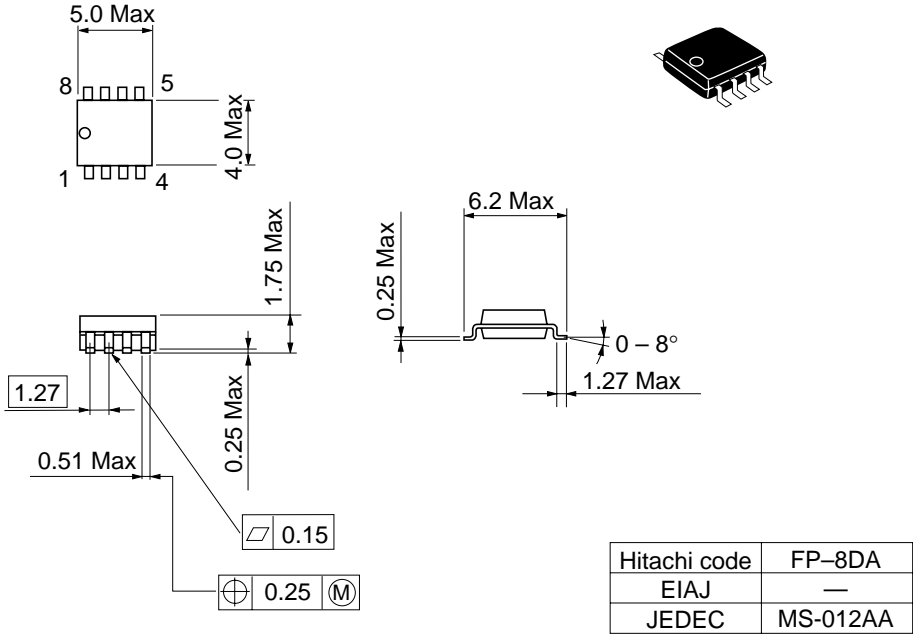


Switching Time Waveform



Package Dimensions

Unit: mm



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Hitachi, Ltd.

Semiconductor & Integrated Circuits.
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

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For further information write to:

Hitachi Semiconductor
(America) Inc.
179 East Tasman Drive,
San Jose, CA 95134
Tel: <1> (408) 433-1990
Fax: <1> (408) 433-0223

Hitachi Europe GmbH
Electronic components Group
Dornacher Straße 3
D-85622 Feldkirchen, Munich
Germany
Tel: <49> (89) 9 9180-0
Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.
Electronic Components Group.
Whitebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA, United Kingdom
Tel: <44> (1628) 585000
Fax: <44> (1628) 778322

Hitachi Asia Pte. Ltd.
16 Collyer Quay #20-00
Hitachi Tower
Singapore 049318
Tel: 535-2100
Fax: 535-1533

Hitachi Asia Ltd.
Taipei Branch Office
3F, Hung Kuo Building, No.167,
Tun-Hwa North Road, Taipei (105)
Tel: <886> (2) 2718-3666
Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
Kowloon, Hong Kong
Tel: <852> (2) 735 9218
Fax: <852> (2) 730 0281
Telex: 40815 HITEC HX

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